

#### AMPMODU | AMPMODU HE 13/HE 14

TE Internal #: 281698-5

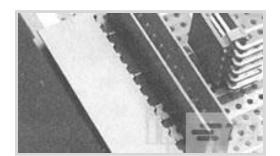
PCB Mount Header, Right Angle, Wire-to-Board, 5 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, AMPMODU HE 13

/HE 14

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Connectors > PCB Connectors > PCB Headers & Receptacles > HE13/HE14 TH Headers, SRRA



Connector System: Wire-to-Board

Number of Positions: 5
Number of Rows: 1

Centerline (Pitch): 2.54 mm [ .1 in ]
PCB Mount Orientation: Right Angle

All HE13/HE14 TH Headers, SRRA (20)

## **Features**

## **Product Type Features**

Connector System	Wire-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header

## **Configuration Features**

Connector Contact Load Condition	Fully Loaded
Number of Positions	5
Number of Rows	1
PCB Mount Orientation	Right Angle

#### **Electrical Characteristics**

Insulation Resistance	1000 ΜΩ
Dielectric Withstanding Voltage (Max)	500 V

## **Body Features**

#### **Contact Features**



Contact Mating Area Length	7 mm
Mating Square Post Dimension	.64 mm[.025 in]
Contact Mating Area Plating Material Thickness	.8 μm[31 μin]
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.63 mm[.025 in]
Termination Post & Tail Length	2.9 mm
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	With
Panel Mount Feature	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
Mating Alignment  PCB Mount Retention	Without
PCB Mount Retention	
PCB Mount Retention  Housing Features	Without
PCB Mount Retention  Housing Features  Housing Material	Without  High Temperature Thermoplastic
PCB Mount Retention  Housing Features  Housing Material  Centerline (Pitch)	Without  High Temperature Thermoplastic
PCB Mount Retention  Housing Features  Housing Material  Centerline (Pitch)  Usage Conditions	Without  High Temperature Thermoplastic  2.54 mm[.1 in]
PCB Mount Retention  Housing Features  Housing Material  Centerline (Pitch)  Usage Conditions  Operating Temperature Range	Without  High Temperature Thermoplastic  2.54 mm[.1 in]
PCB Mount Retention  Housing Features  Housing Material  Centerline (Pitch)  Usage Conditions  Operating Temperature Range  Operation/Application	Without  High Temperature Thermoplastic  2.54 mm[.1 in]  -40 – 100 °C[-40 – 212 °F]
PCB Mount Retention  Housing Features  Housing Material  Centerline (Pitch)  Usage Conditions  Operating Temperature Range  Operation/Application  Circuit Application	Without  High Temperature Thermoplastic  2.54 mm[.1 in]  -40 – 100 °C[-40 – 212 °F]



#### **Packaging Features**

Packaging Quantity	4000
Packaging Type	Box

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts









Also in the Series | AMPMODU HE 13/HE 14





Insertion & Extraction Tools(1)



PCB Headers & Receptacles(83)



Wire-to-Board Connector Assemblies & Housings(151)



Wire-to-Board Connector Contacts(4)

## Customers Also Bought



TE Part #281695-3 HEADER HE14 STRAIGHT 3 P



HE13/HE14 TH Headers, SRRA



TE Part #1375967-4 PC104 PLUS NONSTK NO STNDOFF



TE Part #5-103639-6 07 MTE HDR SRST LATCH .100CL





## **Documents**

## **Product Drawings**

HEADER HE14 RA 5 P

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_281698-5\_G.2d\_dxf.zip

English

## 3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_281698-5\_G.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_281698-5\_G.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

PCB Mount Header, Right Angle, Wire-to-Board, 5 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, AMPMODU HE 13/HE 14



**Product Specifications** 

**Product Specification** 

French

Product Environmental Compliance

MD\_281698-5\_031520172229\_dmtec

English

MD\_281698-5\_031520172229\_dmtec

English